TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (L<sup>2</sup>-π-MOSV)

# 2SJ412

# DC-DC Converter, Relay Drive and Motor Drive Applications

- 4-V gate drive
- Low drain-source ON resistance:  $R_{DS (ON)} = 0.15 \Omega$  (typ.)
- High forward transfer admittance:  $|Y_{fs}| = 7.7 \text{ S}$  (typ.)
- Low leakage current:  $I_{DSS} = -100 \ \mu A \ (max) \ (V_{DS} = -100 \ V)$
- Enhancement mode:  $V_{th}$  = -0.8 to -2.0 V ( $V_{DS}$  = -10 V,  $I_D$  = -1 mA)

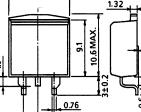
#### Absolute Maximum Ratings (Ta = 25°C)

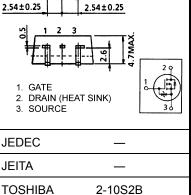
Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V <sub>DSS</sub>	-100	V	
Drain-gate voltage (R <sub>GS</sub> = 20 kΩ)		V <sub>DGR</sub>	-100	V	
Gate-source voltage		V <sub>GSS</sub>	±20	V	
Drain current	DC (Note 1)	۱ <sub>D</sub>	-16	А	
	Pulse (Note 1)	I <sub>DP</sub>	-64	А	
Drain power dissipatio	n (Tc = 25°C)	PD	60	W	
Single pulse avalanche energy (Note 2)		E <sub>AS</sub>	292	mJ	
Avalanche current		I <sub>AR</sub>	-16	А	
Repetitive avalanche energy (Note 3)		E <sub>AR</sub>	6	mJ	
Channel temperature		T <sub>ch</sub>	150	°C	
Storage temperature r	ange	T <sub>stg</sub>	-55 to 150	°C	

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit	
Thermal resistance, channel to case	R <sub>th (ch-c)</sub>	2.08	°C/W	
Thermal resistance, channel to ambient	R <sub>th (ch-a)</sub>	83.3	°C/W	





Weight: 1.5 g (typ.)

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2:  $V_{DD} = -25 \text{ V}$ ,  $T_{ch} = 25^{\circ}\text{C}$  (initial), L = 1.84 mH,  $R_G = 25 \Omega$ ,  $I_{AR} = -16 \text{ A}$ 

Note 3: Repetitive rating: pulse width limited by maximum junction temperature

This transistor is an electrostatic-sensitive device. Please handle with caution.

Unit: mm

10.3MAX

2.5 MAX

1.6 MAX. 0.76

2.54±0.2

1. GATE

Weight: 1.5 g (typ.)

10.3MAX

SOURCE

3.

JEDEC JEITA TOSHIBA

2. DRAIN (HEAT SINK)

10.6 MAX

**12.6MIN** 

54±0.25

ZMA

2-10S1B

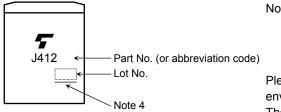
Electrical Characteristics (Ta = 25°C)

Chara	acteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cur	rent	I <sub>GSS</sub>	$V_{GS}$ = ±16 V, $V_{DS}$ = 0 V	_	_	±10	μA
Drain cut-off curr	ent	I <sub>DSS</sub>	$V_{DS}$ = -100 V, $V_{GS}$ = 0 V		_	-100	μA
Drain-source bre	akdown voltage	V (BR) DSS	I <sub>D</sub> = -10 mA, V <sub>GS</sub> = 0 V	-100	_	_	V
Gate threshold ve	oltage	V <sub>th</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -1 mA	-0.8	_	-2.0	V
Gate-source ON resistance		R <sub>DS (ON)</sub>	V <sub>GS</sub> = -4 V, I <sub>D</sub> = -6 A	_	0.25	0.32	Ω
			$V_{GS}$ = -10 V, I <sub>D</sub> = -6 A		0.15	0.21	
Forward transfer	admittance	Y <sub>fs</sub>	$V_{DS} = -10 \text{ V}, \text{ I}_{D} = -6 \text{ A}$	4.5	7.7	—	S
Input capacitance		C <sub>iss</sub>	V <sub>DS</sub> = -10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1100	—	pF
Reverse transfer capacitance		C <sub>rss</sub>		_	210	_	pF
Output capacitance		C <sub>oss</sub>		_	440	_	pF
Switching time	Rise time	tr	$V_{GS} \xrightarrow{O V} \downarrow $	_	18	_	
	Turn-on time	t <sub>on</sub>		_	30	_	ns
	Fall time	t <sub>f</sub>		_	18	_	115
	Turn-off time	t <sub>off</sub>			65	_	
Total gate charge (gate-source plus gate-drain)		Qg	- V <sub>DD</sub> ≈ -80 V, V <sub>GS</sub> = -10 V, I <sub>D</sub> = -16 A	_	48	_	nC
Gate-source charge		Q <sub>gs</sub>		_	29	_	nC
Gate-drain ("miller") charge		Q <sub>gd</sub>	]	_	19		nC

#### Source-Drain Rating and Characteristics (Ta = 25°C)

Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I <sub>DR</sub>	—	_	_	-16	А
Pulse drain reverse current (Note 1)	I <sub>DRP</sub>	—	_	_	-64	А
Forward voltage (diode)	V <sub>DSF</sub>	$I_{DR}$ = -16 A, $V_{GS}$ = 0 V		—	1.7	V
Reverse recovery time	t <sub>rr</sub>	$I_{DR}$ = -16 A, $V_{GS}$ = 0 V		160	_	ns
Reverse recovery charge	Q <sub>rr</sub>	dI <sub>DR</sub> /dt = 50 A/µs	_	0.5	_	μC

#### Marking

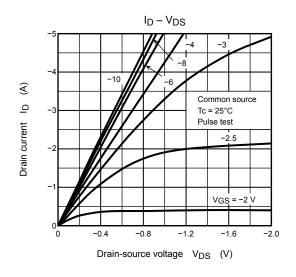


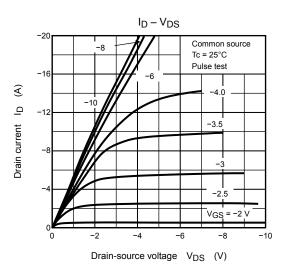
Note 4: A line under a Lot No. identifies the indication of product Labels. Not underlined: [[Pb]]/INCLUDES > MCV

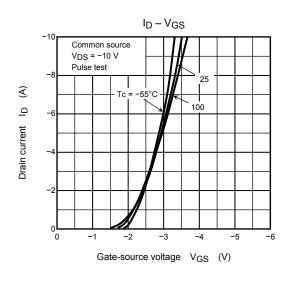
Underlined: [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

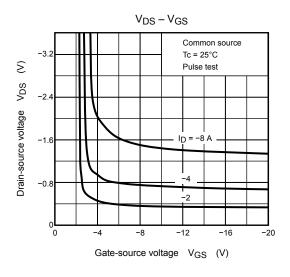
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is the Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

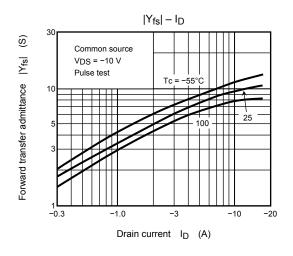
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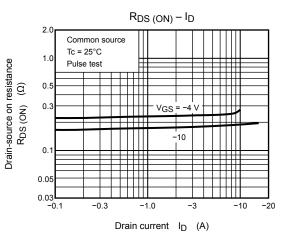




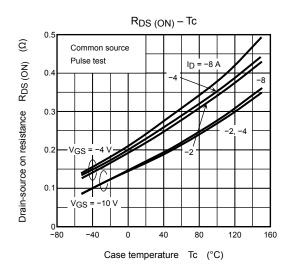


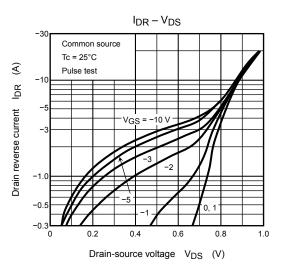


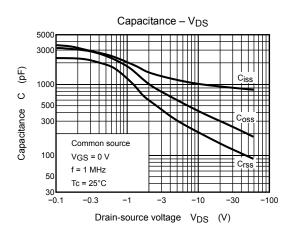




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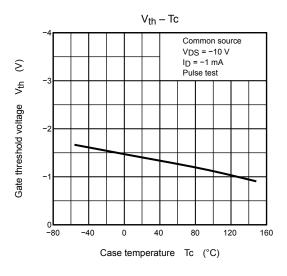
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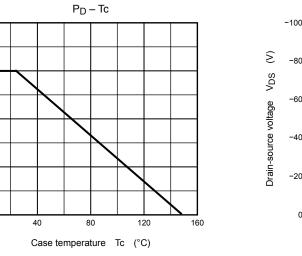
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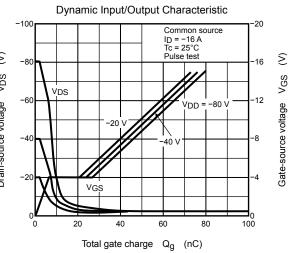
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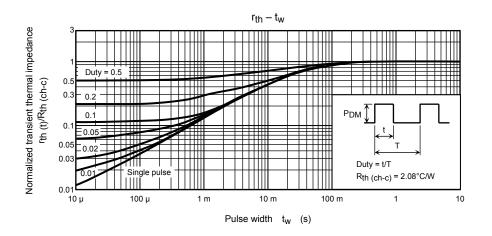
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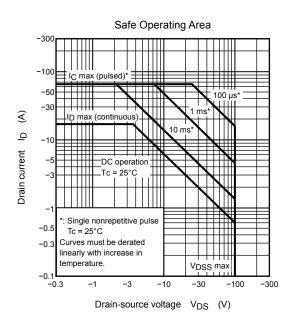
Drain power dissipation

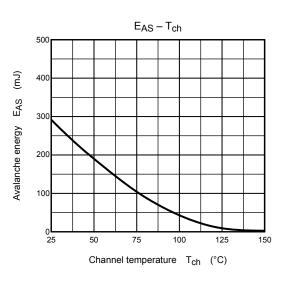


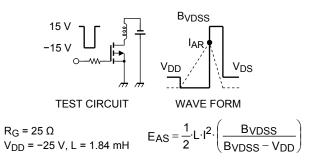












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